# GaAs-IR-Lumineszenzdioden GaAs Infrared Emitters Lead (Pb) Free Product - RoHS Compliant

#### **SFH 415**



#### **Wesentliche Merkmale**

- GaAs-LED mit sehr hohem Wirkungsgrad
- Hohe Zuverlässigkeit
- Gute spektrale Anpassung an Si-Fotoempfänger
- SFH 415: Gehäusegleich mit SFH 300, SFH 203

#### Anwendungen

- IR-Fernsteuerung von Fernseh- und Rundfunkgeräten, Videorecordern, Lichtdimmern
- Gerätefernsteuerungen für Gleich- und Wechsellichtbetrieb
- Sensorik
- Diskrete Lichtschranken

#### **Features**

- Very highly efficient GaAs-LED
- High reliability
- Spectral match with silicon photodetectors
- SFH 415: Same package as SFH 300, SFH 203

#### **Applications**

- IR remote control of hi-fi and TV-sets, video tape recorders, dimmers
- Remote control for steady and varying intensity
- Sensor technology
- Discrete interrupters

Тур Туре	Bestellnummer Ordering Code	Strahlstärkegruppierung <sup>1)</sup> ( $I_{\rm F}$ = 100 mA, $t_{\rm p}$ = 20 ms) Radiant Intensity Grouping <sup>1)</sup> $I_{\rm e}$ (mW/sr)
SFH 415	Q62702-P0296	> 25
SFH 415-U	Q62702-P1137	> 40

 $<sup>^{1)}</sup>$  gemessen bei einem Raumwinkel  $\Omega$  = 0.01 sr / measured at a solid angle of  $\Omega$  = 0.01 sr



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### **Grenzwerte** ( $T_A = 25$ °C) **Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Betriebs- und Lagertemperatur Operating and storage temperature range	$T_{\sf op};T_{\sf stg}$	- 40 + 100	°C
Sperrspannung Reverse voltage	$V_{R}$	5	V
Durchlassstrom Forward current	$I_{F}$	100	mA
Stoßstrom, $t_p = 10 \mu s$ , $D = 0$ Surge current	$I_{FSM}$	3	А
Verlustleistung Power dissipation	$P_{tot}$	165	mW
Wärmewiderstand Thermal resistance	$R_{thJA}$	450	K/W

### **Kennwerte** ( $T_A = 25$ °C) **Characteristics**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Wellenlänge der Strahlung Wavelength at peak emission $I_{\rm F}=100$ mA, $t_{\rm p}=20$ ms	$\lambda_{peak}$	950	nm
Spektrale Bandbreite bei 50% von $I_{\rm max}$ Spectral bandwidth at 50% of $I_{\rm max}$ $I_{\rm F}$ = 100 mA	Δλ	55	nm
Abstrahlwinkel Half angle SFH 415	φ	± 17	Grad
Aktive Chipfläche Active chip area	A	0.09	mm <sup>2</sup>
Abmessungen der aktiven Chipfläche Dimensions of the active chip area	$L \times B$ $L \times W$	0.3 × 0.3	mm <sup>2</sup>
Abstand Chipoberfläche bis Linsenscheitel Distance chip front to lens top SFH 415	Н	4.2 4.8	mm



#### Kennwerte ( $T_A = 25$ °C) Characteristics (cont'd)

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Schaltzeiten, $I_{\rm e}$ von 10% auf 90% und von 90% auf 10%, bei $I_{\rm F}$ = 100 mA, $R_{\rm L}$ = 50 $\Omega$ Switching times, $I_{\rm e}$ from 10% to 90% and from 90% to 10%, $I_{\rm F}$ = 100 mA, $R_{\rm L}$ = 50 $\Omega$	$t_{r},t_{f}$	0.5	μs
Kapazität Capacitance $V_{\rm R}$ = 0 V, $f$ = 1 MHz	$C_{o}$	25	pF
Durchlassspannung Forward voltage $I_{\rm F}$ = 100 mA, $t_{\rm p}$ = 20 ms $I_{\rm F}$ = 1 A, $t_{\rm p}$ = 100 $\mu$ s	$V_{F} \ V_{F}$	1.3 (≤ 1.5) 2.3 (≤ 2.8)	V
Sperrstrom Reverse current $V_{\rm R} = 5 \text{ V}$	$I_{R}$	0.01 (≤ 1)	μΑ
Gesamtstrahlungsfluss Total radiant flux $I_{\rm F}$ = 100 mA, $t_{\rm p}$ = 20 ms	$\Phi_{e}$	22	mW
Temperaturkoeffizient von $I_{\rm e}$ bzw. $\Phi_{\rm e}$ , $I_{\rm F}$ = 100 mA Temperature coefficient of $I_{\rm e}$ or $\Phi_{\rm e}$ , $I_{\rm F}$ = 100 mA	$TC_1$	- 0.5	%/K
Temperaturkoeffizient von $V_{\rm F},I_{\rm F}$ = 100 mA Temperature coefficient of $V_{\rm F},I_{\rm F}$ = 100 mA	$TC_{V}$	-2	mV/K
Temperaturkoeffizient von $\lambda$ , $I_{\rm F}$ = 100 mA Temperature coefficient of $\lambda$ , $I_{\rm F}$ = 100 mA	$TC_{\lambda}$	+ 0.3	nm/K



#### Gruppierung der Strahlstärke $I_e$ in Achsrichtung

gemessen bei einem Raumwinkel  $\Omega$  = 0.01 sr

#### Grouping of Radiant Intensity I<sub>e</sub> in Axial Direction

at a solid angle of  $\Omega$  = 0.01 sr

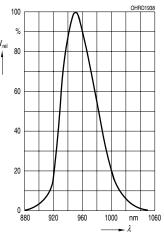
Bezeichnung Parameter	Symbol		Wert Value		
		SFH 415	SFH 415-T <sup>1)</sup>	SFH 415-U	
Strahlstärke Radiant intensity					
$I_{\rm F}$ = 100 mA, $t_{\rm p}$ = 20 ms	$\begin{array}{c} I_{\text{e min}} \\ I_{\text{e max}} \end{array}$	25 -	25 50	40 –	mW/sr mW/sr
Strahlstärke Radiant intensity $I_F = 1 \text{ A}$ ,	I <sub>e typ.</sub>	_	350	450	mW/sr
$t_{\rm p} = 100 \; \mu \rm s$	-e ιγρ.				

<sup>1)</sup> SFH 415-T kann nicht einzeln bestellt werden. / SFH 415-T can not be ordered separately.



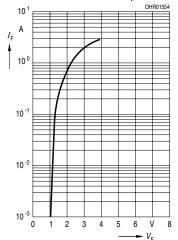
### Relative Spectral Emission

 $I_{rel} = f(\lambda)$ 

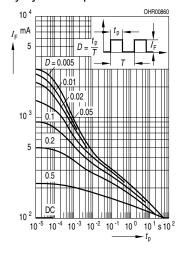


#### **Forward Current**

 $I_{\rm F}$  =  $f(V_{\rm F})$ , single pulse,  $t_{\rm p}$  = 20  $\mu {\rm s}$ 

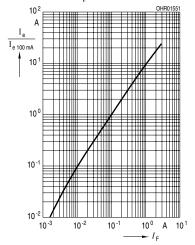


## Permissible Pulse Handling Capability $I_{\rm F}$ = f ( $\tau$ ), $T_{\rm A}$ = 25 °C duty cycle D = parameter

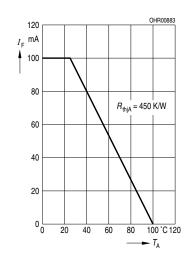


### Radiant Intensity $\frac{I_{\rm e}}{I_{\rm e}\,$ 100 mA = f ( $I_{\rm F}$ )

Single pulse,  $t_p = 20 \mu s$ 

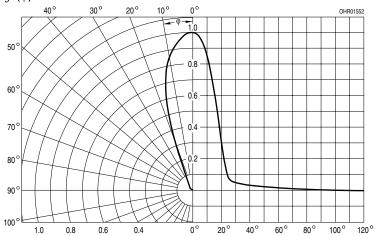


### Max. Permissible Forward Current $I_F = f(T_A)$

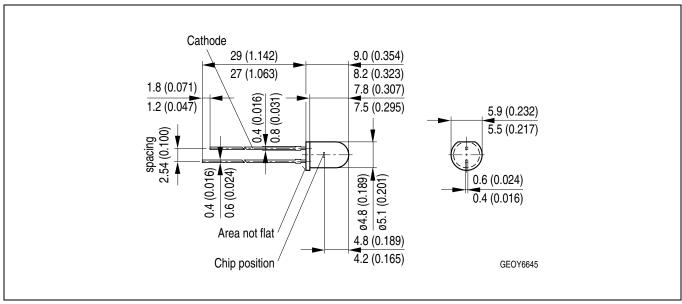


#### **Radiation Characteristics,**

 $I_{rel} = f(\varphi)$ 



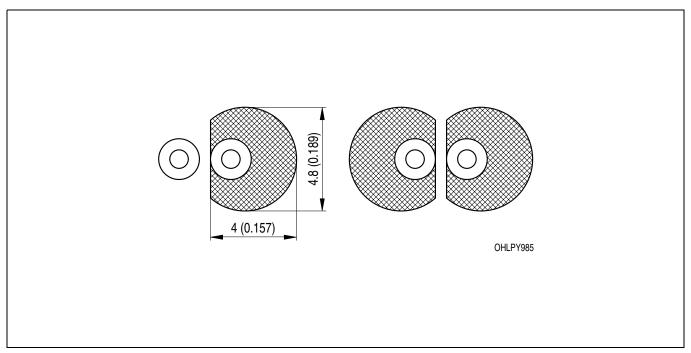
#### Maßzeichnung Package Outlines



Maße in mm (inch) / Dimensions in mm (inch).

### Empfohlenes Lötpaddesign Recommended Solder Pad

Wellenlöten (TTW)
TTW Soldering

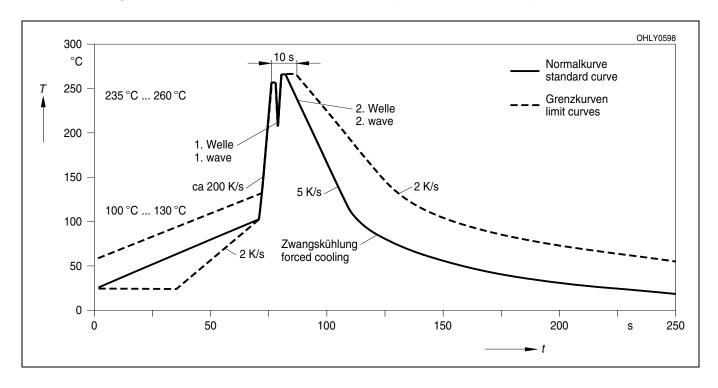


Maße in mm (inch) / Dimensions in mm (inch).



Lötbedingungen **Soldering Conditions** Wellenlöten (TTW) TTW Soldering

(nach CECC 00802) (acc. to CECC 00802)



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